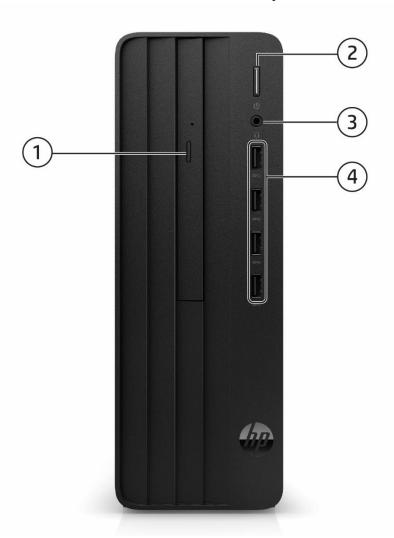
Overview

# HP Pro SFF 290 G9 Desktop PC



- 1. Slim-height Bay supporting an optical disk drive (optional)
- 2. Power Button
- 3. Microphone/Headphone Combo Jack
- 4. (4) SuperSpeed USB 5Gbps signaling rate Ports<sup>1</sup>

### **Not shown**

#### Slots

- (1) PCI Express 4.0 x 16
- (1) PCI Express3.0 x1
- (1) M.2 for WLAN
- (1) M.2 2230/2280 storage
- 1. SuperSpeed USB 5Gbps = USB3.2 Gen1

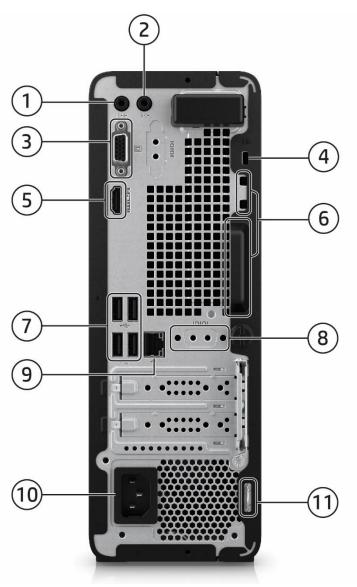
### **Bays**

- (1) 3.5"
- (1) 9.5mm internal optical drive bay



Overview

## HP Pro SFF 290 G9 Desktop PC



- 1. Audio Line out
- 2. Audio Line in
- 3. VGA Port1
- 4. Standard lock slot
- 5. HDMI Port1
- **Not Shown**

Parallel Port (Optional via PCIex1 slot) 4 Serial Port (Optional via PCIe slot) Intrusion Sensor (Optional)

- 6. Integrated accessories cable lock
- 7. (4) USB 2.0 ports
- 8. Serial port (optional)
- 9. RJ-45 Network Connector
- 10. Power Cord Connector
- 11. Padlock Loop

1. Port will be covered up when configured with processor which is without internal graphics.

## **AT A GLANCE**



Overview

#### **AT A GLANCE**

- Windows 11 Pro 64, Win 11 Home 64, Win 11 Pro 64 Downgrade (Win 10 Pro 64)<sup>1</sup> or FreeDOS.
- Intel® Intel® H670 chipset supporting up to Intel® 13th processors featuring Intel® UHD Graphics.
- Supports an optional discrete graphics card.
- Integrated 10/100/1000 Ethernet Controller or ac 2x2 +Bluetooth 5 M.2 2230 PCI-e+USB WW³ or 802.11ac (1x1) Wi-Fi® and Bluetooth® 4.2 Combo³ or Realtek 8852BE Wi-Fi6 +BT5.2 Screw WLAN.
- Up to 64GB DDR4-3200 Unbuffered Memory (UDIMM).
- Independent monitor support via VGA and HDMI interfaces.
- TPM 2.0 support (firmware).
- Supports both Hard Disk Drives and SATA TLC / PCIe® NVMe™ M.2 SSD or PCIe® NVMe™ TLC M.2 SSD.
- 8 USB Ports (including 4 SuperSpeed USB 5Gbps ports).
- 180W 85%/ 90% HE power supply and 240W 92% HE power supply<sup>1</sup>.
- Security cable lock supported (sold separately).
- Intrusion sensor supported (optional).
- Optional HP Care Packs available; terms and conditions vary by country; certain restrictions and exclusions apply<sup>2</sup>.
- 1. Available on select skus only.
- 2. 180W 85%/90% available in select regions only.
- 3. HP Care Packs sold separately. Service levels and response times for HP Care Packs may vary depending on your geographic location. Service starts on date of hardware purchase. Restrictions and limitations apply. For details, visit www.hp.com/go/cpc. HP services are governed by the applicable HP terms and conditions of service provided or indicated to Customer at the time of purchase. Customer may have additional statutory rights according to applicable local laws, and such rights are not in any way affected by the HP terms and conditions of service or the HP Limited Warranty provided with your HP Product.

NOTE: See important legal disclosures for all listed specs in their respective features sections.



Standard Features and Configurable Modules

#### OPERATING SYSTEMS

Preinstalled Windows 11 Pro<sup>1</sup>

Windows 11 Home - HP recommends Windows 11 Pro for Business<sup>1</sup>

Windows 11 Home Single Language - HP recommends Windows 11 Pro for Business<sup>1</sup>

Windows 11 Pro (preinstalled with Windows 10 Pro Downgrade)<sup>1,2</sup>

**FreeDOS** 

- 1. Not all features are available in all editions or versions of Windows. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS update to take full advantage of Windows functionality. Windows is automatically updated and enabled. High speed internet and Microsoft account required. ISP fees may apply and additional requirements may apply over time for updates. See <a href="http://www.windows.com">http://www.windows.com</a>.
- 2. This system is preinstalled with Windows 10 Pro software and also comes with a license for Windows 11 Pro software and provision for recovery software. You may only use one version of the Windows software at a time. Switching between versions will require you to uninstall one version and install the other version. You must back up all data (files, photos, etc.) before uninstalling and installing operating systems to avoid loss of your data.

#### PROCESSORS\*

#### Intel® Celeron® Processors 1,2,3

CPU Intel Celeron G6900 Dual Core 3.4GHz 3200MHz 46W (3.4GHz, 4MB cache, 2 cores)

### Intel® Pentium®1,2

CPU Intel Pentium Gold G7400 Dual Core 3.7GHz 3200MHz 46W (3.7GHz, 6MB cache, 2 cores)

### Intel 12<sup>th</sup> Processors Intel® Core™ i3<sup>1,2,3</sup>

CPU Intel Core i3-12100 4C 3.3GHz 3200MHz 60W (3.3GHz, turbo up to 4.3GHz, 12MB cache, 4 cores)

#### Intel® Core™ i5<sup>1,2,3</sup>

CPU Intel Core i5-12400 6C 2.5GHz 3200MHz 65W (2.5GHz, turbo up to 4.4GHz, 18MB cache, 6 cores) CPU Intel Core i5-12500 6C 3.0GHz 3200MHz 65W (3.0GHz, turbo up to 4.6GHz, 18MB cache, 6 cores)

#### Intel® Core™ i7<sup>1,2,3</sup>

CPU Intel Core i7-12700 12C 2.1GHz 3200MHz 65W (2.1GHz, Up to 4.8GHz with Intel® Turbo Boost4, 25MB cache, 12 cores)

# Intel 13th Processors Intel® Core™ i3¹

CPU Intel Core i3-13100 4C 3.4GHz 3200MHz 60W (3.4GHz, turbo up to 4.5GHz, 12MB cache, 4 cores)

#### Intel® Core™ i51

CPU Intel Core i5-13400 10C 2.5GHz 3200MHz 65W (2.5GHz, turbo up to 4.6GHz, 20MB cache, 10 cores)

CPU Intel Core i5-13400F 10C 2.5GHz 3200MHz 65W (2.5GHz, turbo up to 4.6GHz, 20MB cache, 10 cores)

CPU Intel Core i5-13500 14C 2.5GHz 3200MHz 65W (2.5GHz, turbo up to 4.8GHz, 24MB cache, 14 cores)

CPU Intel Core i5-13600 14C 2.7GHz 3200MHz 65W (2.7GHz, turbo up to 5.0GHz, 24MB cache, 14 cores)

#### Intel® Core™ i71

CPU Intel Core i7-13700 16C 2.1GHz 3200MHz 65W (2.1GHz, Up to 5.2GHz with Intel® Turbo Boost², 30MB cache, 16 cores)



## Standard Features and Configurable Modules

- 1. Your product does not support Windows 8 or Windows 7, In accordance with Microsoft's support policy, HP does not support the Windows® 8 or Windows 7 operating system on products configured with Intel 8th generation and forward processors or provide any Windows® 8 or Windows 7 drivers on http://www.support.hp.com
- 2. Multicore is designed to improve performance of certain software products. Not all customers or software applications will necessarily benefit from use of this technology. Performance and clock frequency will vary depending on application workload and your hardware and software configurations. Intel's numbering, branding and/or naming is not a measurement of higher performance.
- 3. In accordance with Microsoft's support policy, HP does not support the Windows 8 or Windows 7 operating system on products configured with Intel and AMD 7th generation and forward processors or provide any Windows 8 or Windows 7 drivers on http://www.support.hp.com.
- 4. Intel® Turbo Boost technology requires a PC with a processor with Intel Turbo Boost capability. Intel Turbo Boost performance varies depending on hardware, software and overall system. See http://www.intel.com/technology/turboboost for more information.
- \*NOTE: Not all processors are available; it varies by version.



Standard Features and Configurable Modules

#### **CHIPSET**

Intel® H670 Chipset

#### **GRAPHICS**

#### Integrated<sup>1,2</sup>

Intel® UHD
Graphics 770 (integrated on 13<sup>th</sup> Core i7-i5 processors)
Intel® UHD
Graphics 730 (integrated on 13<sup>th</sup> Core i5-i3 processors)
Graphics 710 (integrated on Pentium and Celeron)

#### **Discrete Graphics**

NVIDIA® Quadro® T400 (4 GB GDDR6 dedicated) AMD Radeon™ RX 6300XT Graphics (2 GB GDDR6)

- 1. HD content required to view HD images.
- 2. Integrated Intel software is available on select models only and requires separately purchased projector, tv or computer monitor with an integrated or external receiver. External receivers connect to the projector, tv or computer monitor via a standard VGA, HDMI cable, also sold separately.

#### **MEMORY**

Both slots are customer accessible / upgradeable, Supports Dual Channel Memory

Form Factor	Туре	Maximum	# of Slots
Small Form Factor	DDR4 3200	64 GB capacity	2 DIMM <sup>1</sup>
4GB DDR4-3200 UDIMM NECC	(1x4GB)		
8GB DDR4-3200 UDIMM NECC	(1x8GB)		
8GB DDR4-3200 UDIMM NECC	(2x4GB)		
16GB DDR4-3200 UDIMM NECC	C (1x16GB)		
16GB DDR4-3200 UDIMM NECC	C (2x8GB)		
32GB DDR4-3200 UDIMM NECC	C (1x32GB)		
32GB DDR4-3200 UDIMM NECC			
64GB DDR4-3200 UDIMM NECC	C (2x32GB)		

1. Memory modules support data transfer rates up to 3200 MT/s; actual data rate is determined by the system's configured processor. See processor specifications for supported memory data rate.



Standard Features and Configurable Modules

#### STORAGE AND DRIVES

**NOTE:** Starting from November 1<sup>st</sup>, 2023, all shipments will require Windows to be installed when selecting a SSD. HDD can only be configured as additional data drives and not as the boot drive.

#### SATA3 - 3.5" or 2.5" 6Gb/s HDDs\*

2TB 7200 RPM SATA Hard Disk Drive 1TB 7200 RPM SATA Hard Disk Drive 500GB 7200 RPM SATA Hard Disk Drive<sup>1</sup>

#### 1. Available on select skus only.

**NOTE:** For hard drives and solid state drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB (for Windows) of system disk is reserved for the system recovery software.

#### M.2 Solid State Drives

256GB\* M.2 NVMe 512GB\* M.2 NVMe 1TB\* M.2 NVMe 128GB\* M.2 2280 PCIe NVMe Three Layer Cell SSD <sup>1</sup> 256GB\* M.2 2280 PCIe NVMe Three Layer Cell SSD 512GB\* M.2 2280 PCIe NVMe Three Layer Cell SSD 1TB\* M.2 2280 PCIe NVMe Three Layer Cell SSD

#### 1. Available on select skus only.

**NOTE\***: For hard drives and solid state drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36 GB (for Windows) of system disk is reserved for the system recovery software.

#### OPTICAL DISC DRIVES

DVD-ROM 9.5mm<sup>2</sup> DVD-Writer 9.5mm<sup>2</sup>

2. Optical drives are optional or add on features. HD-DVD disks cannot be played on this drive. No support for DVD-RAM. Actual speeds may vary. Don't copy copyright-protected materials.

### **NETWORKING/COMMUNICATIONS**

#### Networking

Integrated 10/100/1000M GbE LAN

#### Wi-Fi® and Bluetooth®

Realtek RTL8822CE-CG 802.11a/b/g/n/ac (2x2) with Bluetooth® wireless card M.2 PCIe®1 Realtek RTL8821CE-CG 802.11a/b/g/n/ac (1x1) with Bluetooth® wireless card M.2 PCIe®1 Realtek 8852BE Wi-Fi6 +BT5.2 wireless card Screw WLAN<sup>2</sup>

- 1. Wireless cards are optional or add-on features and requires separately purchased wireless access point and internet service. Availability of public wireless access points limited. Wi-Fi 5 (802.11 ac) is backwards compatible with prior 802.11 specs.
- 2. Wireless access point and Internet service required and sold separately. Availability of public wireless access points limited. Wi-Fi 6 (802.11ax) is backwards compatible with prior 802.11 specs.



Standard Features and Configurable Modules

## **AUDIO/MULTIMEDIA**

Realtek ALC3867-CG Integrated Hi-Definition Audio Combo Jack, Headphone/ Microphone Line-in/ Line-out (3.5mm)



Standard Features and Configurable Modules

### **KEYBOARDS/POINTING DEVICES/BUTTONS AND FUNCTIONS KEYS**

### Keyboard

HP USB 320K Keyboard HP 125 Wired Keyboard HP 125 Antimicrobial Wired Keyboard

#### Mouse

HP Wired Desktop 320M mouse HP 125 Wired Mouse HP 128 Laser Wired Mouse HP 125 Antimicrobial Wired Mouse (China only)

## **PORTS**

#### **Front**

Slim-height Bay - supporting an optical disk drive (optional)
(4) SuperSpeed USB 5Gbps signaling rate
Microphone/Headphone Combo Jack
Power Button

#### **Not Shown**

- (1) PCI Express 4.0 x 16
- (1) PCI Express 3.0 x1
- (1) M.2 for WLAN
- (1) M.2 2230/2280 storage

### Rear

**Audio Line out** 

**Audio Line in** 

**HDMI Port** 

Standard lock slot

**VGA Port** 

(4) USB 2.0 port

**RJ-45 Network Connector** 

**Power Cord Connector** 

Padlock loop

**Integrated Accessories Cable Lock** 

Serial port (optional)



## Standard Features and Configurable Modules

#### **Not Shown**

- (1) Parallel Port (Optional via PCIex1 slot)
- (1) 4x Serial port (Optional via PCIex1 slot)1
- (1) PS/2 Port (Optional)
- (1) Intrusion Sensor (Optional)
- 1. Available for selected regions

#### **BAYS**

- (1) 3.5" internal storage
- (1) 9.5mm internal optical drive bay

#### SOFTWARE COMPONENTS AND APPLICATIONS WITH WINDOWS

#### **Security and Protection**

McAfee\* LiveSafe™1

#### **Productivity**

Microsoft 365 (sold separately and requires Internet access for activation)

Dropbox<sup>2</sup>

#### **ODD Playback**

sMedio True DVD for HP

#### **App Stores and Content Purchasing**

Amazon<sup>4</sup>

### **HP Utilities and Support**

**HP Documentation** 

**HP JumpStarts** 

HP Audio Switch⁵

HP Support Assistant<sup>6</sup>

myHP

### **BTB**

**HP Setup Integrated 00BE** 

#### Hardware Enabling Drivers or software utility

**HP System Event Utility** 

### \*NOTE: Available for LA region only.

- 1. Free 1-year subscription of McAfee LiveSafe service included. Internet access required and not included. Subscription required after expiration
- 2. New Dropbox users are eligible to get 25 GB of Dropbox space free for 12 months from date of registration. For complete details and terms of use, including cancellation policies, visit the Dropbox website at https://www.dropbox.com/help/space/hp-promotion. Internet service required and not included.
- 3. Simply sign up and start using Xerox® DocuShare® Go. No credit card. No obligation. Data will become unavailable unless a subscription is



## Standard Features and Configurable Modules

entered before the end of the 30 day free trial period. See visit http://www.xerox.com/docusharego for details.

- 4. Internet access required and not included.
- 5. Easily switch between speaker and microphone sources with intuitive controls and a consistent app experience
- 6. For more information visit hp.com/go/hpsupportassistant [Link will vary outside of the U.S.] HP Support Assistant is available for Android and Windows based PCs.

### **POWER**

#### **Power Supply**

180W

EPA85 Full range 115V/230V EPA90 Full range 115V/230V

240W

EPA92 Full range

#### **WEIGHT AND DIMENSIONS**

(configured with 1 HDD and 1 ODD)

**Chassis** (W x D x H) 3.74 x 11.93 x 10.63 in (95 x 303 x 270 mm) (w/bezel)

System Weight 8.82 lbs / 4 kg\*

#### UNIT ENVIRONMENTAL AND OPERATING CONDITIONS

**General Unit Operating Guidelines** 

# Environmental and Industry

- Keep the computer away from excessive moisture, direct moisture and the extremes of heat and cold, to ensure that unit is operated within the specified operating range.
- Leave a 10.2 cm (4 in) clearance on all vented sides of the computer to permit the required airflow.
- Never restrict airflow into the computer by blocking any vents or air intakes.
- Do not stack computers on top of each other or place computers so near each other that they are subject to each other's re-circulated or preheated air.
- Occasionally clean the air vents on the front, back, and any other vented side of the computer. Lint, dust and other foreign matter can block the vents and limit the airflow.
- If the computer is to be operated within a separate enclosure, intake and exhaust ventilation must be provided on the enclosure, and the same operating guidelines listed above will still apply.

**Temperature Range Operating:** 5° to 35° C<sup>1</sup>

Non-operating: -30° to 60°1

**Relative Humidity** Operating: 5% to 90% (non-condensing at ambient)

**Non-operating:** 5% to 90% (non-condensing at ambient)

Maximum Altitude Operating: 5,000 m

(unpressurized) Non-operating: 50,000 ft (15240 m)

1. Operating temperature is de-rated 1.0 deg C per 300 m (1000 ft) to 3000 m (10,000 ft) above sea level, no direct sustained sunlight. Maximum rate of change is 10 deg C/Hr. The upper limit may be limited by the type and number of options installed.



<sup>\*</sup>NOTE: Weight varies by configuration and component

Standard Features and Configurable Modules

Eco-Label Certifications & declarations  System Configuration	This product has received or is in the product has received or is in the product has belied with one or more of the IT ECO declaration  • US ENERGY STAR®  • US Federal Energy Management Pro  • EPEAT Silver registered in the United your country.  • China Energy Conservation Program  • China State Environmental Protection  • Taiwan Green Mark  • Commission Regulation (EC) No 617	gram (FEMF d States. Se (CECP) on Administ /2013 (ErP )	o) e http://www.epo ration (SEPA) Lot 3)	eat.net for registration status in
Energy Consumption	Desktop model is based on a "Typicall	ly Configure	ed Desktop".	
(in accordance with US ENERGY STAR® test method)	115VAC, 60Hz	230VA	C, 50Hz	100VAC, 50Hz
Normal Operation (Short idle)	12.46W	12.	51W	12.40W
Normal Operation (Long idle)	10.16W		22W	10.02W
Sleep	1.76W	1.7	75W	1.76W
Off	0.38W	0.4	11W	0.41W
	family. HP computers marked with the ENERGY STAR® Logo are compliant with the applicable U.S. Environmental Protection Agency (EPA) ENERGY STAR® specifications for computers. If a model family does not offer ENERGY STAR® compliant configurations, then energy efficiency data listed is for a typically configured PC featuring a hard disk drive, a high efficiency power supply, and a Microsoft Windows® operating system. Search keyword generator on HP's 3rd party option store for solar generator accessories at http://www.hp.com/go/options.			
Heat Dissipation*	115VAC, 60Hz	230VA	C, 50Hz	100VAC, 50Hz
Normal Operation (Short idle)	42.49 BTU/hr		BTU/hr	42.28 BTU/hr
Normal Operation (Long idle)	34.65 BTU/hr	34.85	BTU/hr	34.17 BTU/hr
Sleep	6.00 BTU/hr	5.97	BTU/hr	6.00 BTU/hr
Off	1.30 BTU/hr	1.40	BTU/hr	1.40 BTU/hr
	<b>NOTE:</b> Heat dissipation is calculated based one hour.	d on the mea	sured watts, assun	ning the service level is attained for
Declared Noise Emissions (in accordance with ISO 7779 and ISO 9296)	Sound Power (L <sub>WAd</sub> , bels)		Sound Pressure (L <sub>pAm</sub> , decibels)	
Typically Configured – Idle	3.2		19.7	
	3.3		20.7	
Fixed Disk – Random writes	3.3			20.7
Fixed Disk – Random writes Optical Drive – Sequential reads	4.5			38.2
Fixed Disk – Random writes Optical Drive – Sequential		ed in the pro	duct may include	38.2 r several years. Upgradeable e:



Standard Features and Configurable Modules

	Battery size: CR2032	(coin cell)		
	Battery type: Lithium			
dditional Information	• This product is in compliance with the Restrictions of Hazardous Substances (RoHS) directive - 2011/65/EC.			
	1	esigned to comply with the Waste Electrical and Electr	onic Equipment	
		mpliance with California Proposition 65 (State of Califo	ornia; Safe Drinking	
	Water and Toxic Enfo	rcement Act of 1986).		
	-	mpliance with the IEEE 1680.1 (EPEAT) standard at the	e <silver> level, see</silver>	
	http://www.epeat.net			
		ing over 25 grams used in the product are marked per	IS011469 and	
	ISO1043.	30 30/		
		ns 28.2% post-consumer recycled plastic (by wt.)	_	
a also aima Mataviala		% recycle-able when properly disposed of at end of life		
ackaging Materials	External: Internal:	PAPER/Corrugated PAPER/Molded Pulp	540 g	
	internat:	PLASTIC/Polyethylene low density - LDPE	350 g	
-4	This are dead do no set		30 g	
laterial Usage		t contain any of the following substances in excess of r	regulatory limits	
		ral Specification for the Environment at		
		npinfo/globalcitizenship/environment/pdf/gse.pdf):		
	• Asbestos			
	Certain Azo Colorant			
		Flame Retardants – may not be used as flame retarda	nts in plastics	
	Cadmium			
	<ul> <li>Chlorinated Hydroca</li> </ul>			
	<ul> <li>Chlorinated Paraffin</li> </ul>	ns .		
	<ul> <li>Formaldehyde</li> </ul>			
	<ul> <li>Halogenated Diphen</li> </ul>			
	<ul> <li>Lead carbonates and</li> </ul>			
	<ul> <li>Lead and Lead comp</li> </ul>			
	Mercuric Oxide Batte			
		st not be used on the external surface designed to be f	frequently handled o	
	carried by the user.			
	<ul> <li>Ozone Depleting Sul</li> </ul>			
	<ul> <li>Polybrominated Bipl</li> </ul>			
	<ul> <li>Polybrominated Bipl</li> </ul>			
	<ul> <li>Polybrominated Bipl</li> </ul>			
	<ul> <li>Polychlorinated Biph</li> </ul>			
	Polychlorinated Terr			
	, ,	PVC) — except for wires and cables, and certain retail pa	ackaging has been	
		rom most applications.		
	Radioactive Substan			
	• Tributyl Tin (TBT), Ti	riphenyl Tin (TPT), Tributyl Tin Oxide (TBTO)		
ackaging Usage	HP follows these guidelines to decrease the environmental impact of product packaging:			
	Eliminate the use of materials.	heavy metals such as lead, chromium, mercury and ca	admium in packaging	
		ozone-depleting substances (ODS) in packaging mate	rials.	
		naterials for ease of disassembly.		
			na materiala	
		post-consumer recycled content materials in packagii	_	
		le packaging materials such as paper and corrugated r		
		ght of packages to improve transportation fuel efficie		
	Plastic nackaging ma	aterials are marked according to ISO 11469 and DIN 61	120 standards	



Standard Features and Configurable Modules

# End-of-life Management and Recycling

HP Inc. offers end-of-life HP product return and recycling programs in many geographic areas. To recycle your product, please go to: http://www.hp.com/go/reuse-recycle or contact your nearest HP sales office. Products returned to HP will be recycled, recovered or disposed of in a responsible manner.

The EU WEEE directive (2002/95/EC) requires manufacturers to provide treatment information for each product type for use by treatment facilities. This information (product disassembly instructions) is posted on the Hewlett Packard web site at: http://www.hp.com/go/recyclers. These instructions may be used by recyclers and other WEEE treatment facilities as well as HP OEM customers who integrate and re-sell HP equipment.

**Global Citizenship Report** 

http://www.hp.com/hpinfo/globalcitizenship/gcreport/index.html

**Eco-label certifications** 

http://www8.hp.com/us/en/hp-information/environment/ecolabels.html

ISO 14001 certificates:

http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/PC\_GBU\_Product\_Design\_ISO\_1

4K\_Certificate.pdf

and

http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/cert.pdf

### **SERVICE AND SUPPORT**

On-site Warranty¹: Available three-year (3-3-3) or one-year (1-1-1) limited warranty (varies by country) delivers on-site, next business day² service for parts and labor and complimentary limited technical support³. Three-year onsite and labor are not available in all countries. Service offers terms up to 5 years by choosing an optional HP Care Service⁴. To choose the right level of service for your HP product, visit HP Care Pack Central: http://www.hp.com/go/cpc.

- 1. Terms and conditions may vary by country. Certain restrictions and exclusions apply. Other warranty variations may be offered in your region.
- 2. On-site service may be provided pursuant to a service contract between HP and an authorized HP third-party provider and is not available in certain countries. Global service response times are based on commercially reasonable best effort and may vary by country.
- 3. Technical support applies only to HP-configured and third-party HP qualified hardware and software.
- 4. HP Care Packs are sold separately. Service levels and response times for HP Care Packs may vary depending on your geographic location. Service starts on date of hardware purchase. Restrictions and limitations apply. For details, visit http://www.hp.com/go/cpc. HP services are governed by the applicable HP terms and conditions of service provided or indicated to Customer at the time of purchase. Customer may have additional statutory rights according to applicable local laws, and such rights are not in any way affected by the HP terms and conditions of service or the HP Limited Warranty provided with your HP Product.

#### **GRAPHICS**



Technical Specifications - Graphics

#### **GRAPHICS**

ntel® UHD Graphics (integrated)	
Integrated	
Multimode capable; supports HDCP, Display Port Audio (2 streams), HBR2 link rates and Multi-Stream Technology for a maximum of 4 displays connected to any output controlled by Intel® Graphics	
Supports HDMI 2.0a features Supports HDCP 2.2 Supports audio over HDMI	
VGA output	
The actual amount of maximum graphics memory can be >4GB. System memory is allocated for graphics as needed using Intel's Dynamic Video Memory Technology (DVMT), to provide an optimal balance between graphics and system memory use.	
up to 10 bits/color	
HEVC 10b Enc/Dec HW VP9 10b Dec HW HDR Rec. 2020 DX12	
Max. Resolution (VGA) 2048 x 1536 @60Hz Max. Resolution (HDMI) 7680 x 4320 @60Hz	

**Note:** The actual amount of maximum graphics memory can be less than the amounts listed above depending upon your computer's configuration.

**Note:** other resolutions may be available but are not recommended as they may not have been tested and qualified by HP Only supported on displays connected to the external DisplayPort™ connector.

### **NVIDIA®** Quadro T400 Graphics Card

Engine Clock2100 MHzMemory Clock5001 MHzMemory Size (width)4GB (64-bit)Memory Type256M x 16 GDDR6Max. Resolution (DP)7680x4320@60Hz

Multi Display Support4 displaysHDCP ComplianceYesRear I/O connectors (bracket)mDPx3

**Cooling (active/passive)** Active fan-sink (Active cooling with dynamic speed)

Total power consumption (W) 30W

PCB form-factor with bracket LP PCB with LP bracket

AMD® Radeon™ RX 6300 2GB Graphics Card

**Engine Clock** 1512 MHz (Game) 2040MHz (Boost)

Memory Clock 2000 MHz



# Technical Specifications - Graphics

Memory Size(width) 2GB

Memory Type 512M x 32 GDDR6

 Max. Resolution (HDMI)
 7680x4320x36bpp @60Hz

 Max. Resolution (DP)
 7680x4320x24bpp @120Hz

Multi Display Support 2 displays

**HDCP Compliance** Yes

Rear I/O connectors (bracket) HDMIx1+DPx1
Cooling (active/passive) Active fan-sink

**Total power consumption (W)** 32W

PCB form-factor with bracket FH LP PCB with LP/FH bracket



Technical Specifications – Storage

#### **STORAGE**

**NOTE:** Starting from November 1<sup>st</sup>, 2023, all shipments will require Windows to be installed when selecting a SSD. HDD can only be configured as additional data drives and not as the boot drive.

## HP 2TB\* 7.2K rpm SATA 6.0Gb/s 3.5" Hard Disk Drive\*

Capacity 2TB

**Rotational Speed** 7,200 rpm Interface SATA 6Gb/s NCQ

**Buffer Size** 64 MB

 Logical Blocks
 3,907,029,168

 Seek Time
 Read: <8.5 ms</td>

Write: <9.5 ms

 Height
 1.028 in/26.11 mm

 Width
 4.0 in/101.6 mm

**Operating Temperature** 32° to 140° F (0° to 60° C)

**NOTE:** For hard drives and solid state drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB (for Windows) of system disk is reserved for the system recovery software.

### 1TB 7.2K rpm SATA 6.0Gb/s 3.5" Hard Disk Drive

Capacity 1TB

**Rotational Speed** 7,200 rpm

Interface Serial ATA 3.0 (6.0 Gb/s)

Buffer Size 32 MB

 Logical Blocks
 1,953,525,168

 Seek Time
 Read: <8.5 ms</td>

 Write: <9.5 ms</th>

Full-Stroke: 21 ms

Height 1 in/2.54 cm

Width Media diameter: 3.5 in/8.89 cm

Physical size: 4 in/10.2 cm

**Operating Temperature** 41° to 131° F (5° to 55° C)

**NOTE:** For hard drives and solid state drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB (for Windows) of system disk is reserved for the system recovery software.

## 500GB 7.2K rpm SATA 6.0Gb/s 3.5" Hard Disk Drive

Capacity 500GB
Rotational Speed 7,200 rpm

**Drive Type** Serial ATA 3.0 (6.0 Gb/s)

Interface 32 MB
Buffer Size 976,773,168



Technical Specifications – Storage

Seek Time Single Track: 2.0 ms

Average: 11 ms Full-Stroke: 21 ms

Height 1 in/2.54 cm

Width Media diameter: 3.5 in/8.89 cm

Physical size: 4 in/10.2 cm

**Operating Temperature** 41° to 131° F (5° to 55° C)

**NOTE:** For hard drives and solid state drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB (for Windows) of system disk is reserved for the system recovery software.

## 128GB M.2 2280 PCIe NVMe Three Layer Cell SSD

Drive Weight < 10g
Capacity 128GB
Height 2.38mm
Length 80mm
Width 22mm

InterfacePCIE Gen3x4Maximum Sequential ReadUp to 2800MB/sMaximum Sequential WriteUp to 600MB/sLogical Blocks250,069,680

**Operating Temperature** 0° to 70°C (32° to 158°F) [ambient temp]

**Features** APST; ASPM L1.2; NVME spec 1.2

**NOTE:** For hard drives and solid state drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB (for Windows) of system disk is reserved for the system recovery software.

#### 256GB M.2 2280 PCIe NVMe Three Layer Cell SSD

Drive Weight < 10g
Capacity 256GB
Height 2.38mm
Length 80mm
Width 22mm

InterfacePCIE Gen3x4Maximum Sequential ReadUp to 2700MB/sMaximum Sequential WriteUp to 1000MB/sLogical Blocks500,118,192

**Operating Temperature** 0° to 70°C (32° to 158°F) [ambient temp]

**Features** APST; ASPM L1.2; NVME spec 1.2

**NOTE:** For hard drives and solid state drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB (for Windows) of system disk is reserved for the system recovery software.



Technical Specifications – Storage

### 512GB M.2 2280 PCIe NVMe Three Layer Cell SSD

Drive Weight< 10g</td>Capacity512GBHeight2.38mmLength80mmWidth22mmInterfacePCIE Gen3x4

Maximum Sequential ReadUp to 2900MB/sMaximum Sequential WriteUp to 1100MB/sLogical Blocks1,000,215,216

**Operating Temperature** 0° to 70°C (32° to 158°F) [ambient temp]

**Features** APST; ASPM L1.2; NVME spec 1.2

**NOTE:** For hard drives and solid state drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB (for Windows) of system disk is reserved for the system recovery software.

## 1TB M.2 2280 PCIe NVMe Three Layer Cell SSD

**Drive Weight** < 10q Capacity 1TB Height 2.3mm Length 80mm Width 22mm Interface PCIE NVMe **Maximum Sequential Read** Up to 2900MB/s **Maximum Sequential Write** Up to 1100MB/s **Logical Blocks** 2,000,409,264

**Operating Temperature** 0° to 70°C (32° to 158°F) [ambient temp]

**Features** Pyrite

**NOTE:** For hard drives and solid state drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB (for Windows) of system disk is reserved for the system recovery software.

#### 256GB M.2 2280 PCIe NVMe SSD

Drive Weight< 10g</td>Capacity256GBHeight2.38mmLength80mmWidth22mm

InterfacePCIE NVMe Gen4x4Maximum Sequential ReadUp to 3000MB/sMaximum Sequential WriteUp to 1700MB/sLogical Blocks500,118,192

**Operating Temperature** 0° to 70°C (32° to 158°F) [ambient temp]

**Features** APST; ASPM L1.2; NVME spec 1.2



Technical Specifications – Storage

**NOTE:** For hard drives and solid state drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB (for Windows) of system disk is reserved for the system recovery software.

#### 512GB M.2 2280 PCIe NVMe SSD

Drive Weight< 10g</td>Capacity512GBHeight2.38mmLength80mmWidth22mm

InterfacePCIE NVMe Gen4X4Maximum Sequential ReadUp to 3000MB/sMaximum Sequential WriteUp to 1800MB/sLogical Blocks1,000,215,216

**Operating Temperature** 0° to 70°C (32° to 158°F) [ambient temp]

Features APST; ASPM L1.2; NVME spec 1.2

**NOTE:** For hard drives and solid state drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB (for Windows) of system disk is reserved for the system recovery software.

### 1TB M.2 2280 PCIe NVMe SSD

Drive Weight < 10g
Capacity 1TB
Height 2.3mm
Length 80mm
Width 22mm

InterfacePCIE NVMe Gen4x4Maximum Sequential ReadUp to 3500MB/sMaximum Sequential WriteUp to 2500MB/sLogical Blocks2,000,409,264

**Operating Temperature** 0° to 70°C (32° to 158°F) [ambient temp]

**Features** Pyrite

**NOTE:** For hard drives and solid state drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB (for Windows) of system disk is reserved for the system recovery software.



Technical Specifications – Storage

#### **500GB 7200RPM 2.5in SATA HDD**

Capacity500GBRotational Speed7,200 rpmInterfaceSATA 6 Gb/sBuffer Size32 MB

Logical Blocks 976,773,168
Seek Time 12 ms (Average)

Height0.267 in/6.8 mm (nominal)Width (nominal)2.75 in/70 mm (nominal)Operating Temperature41° to 131° F (5° to 55° C)

**NOTE:** For hard drives and solid state drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB (for Windows) of system disk is reserved for the system recovery software.

#### 1TB 7200RPM 2.5in SATA HDD

Capacity 1TB

Rotational Speed 7,200 rpm
Interface SATA 6 Gb/s
Buffer Size 32 MB

Logical Blocks 1,953,525,168
Seek Time 12 ms (Average)

Height0.374 in/9.5 mm (nominal)Width (nominal)2.75 in/70 mm (nominal)Operating Temperature41° to 131° F (5° to 55° C)

**NOTE:** For hard drives and solid state drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB (for Windows) of system disk is reserved for the system recovery software.



Technical Specifications — Optical Disc Drives

#### **OPTICAL DISC DRIVES**

### HP 9.5mm Desktop G2 Slim DVD Writer Drive

Height 9.5 mm height

Orientation Either horizontal or vertical

Interface type SATA/ATAPI

Disc recording capacity Up to 8.5 GB DL or 4.7 GB standard

Dimensions (W x H x D) 5.04 x 0.37 x 5.0 in (128 x 9.5 x 127 mm) without bezel

Weight (max) 0.31 lb (140 g)

**Read Speeds** DVD-R DL - Up to 6X

DVD+R - Up to 8X DVD+RW - Up to 8X DVD+R DL - Up to 6X DVD-R - Up to 8X DVD-RW - Up to 6X CD-R - Up to 24X CD-RW - Up to 10X

DVD-RW, DVD+RW - Up to 8X DVD-R DL. DVD+R DL - Up to 8X DVD+R, DVD-R - Up to 8X

DVD-ROM DL, DVD-ROM - Up to 8X

CD-ROM, CD-R - Up to 24X

CD-RW - Up to 24X

Access time Random DVD-ROM: 170 ms (typical), CD-ROM: 170 ms (typical) Full Stroke DVD-ROM: 320 ms (typical), CD-ROM: 320 ms (typical)

(typical reads, including

settling)

Stop Time 6 seconds (typical)

Source Slimline SATA DC power receptacle Power

> DC Power Requirement 5 VDC ± 5%-100 mV ripple p-p DC Current 5 VDC (< 1000 mA typical, 1600 mA maximum)

**Environmental conditions** 

(operating - non-condensing)

Temperature 41° to 122° F (5° to 50° C)

Relative Humidity 10% to 80%

Maximum Wet Bulb Temperature 84° F (29° C)

## HP 9.5mm Desktop G2 Slim DVD-ROM Drive

Height 9.5 mm height

Orientation Either horizontal or vertical

Interface type SATA/ATAPI

Disc recording capacity Up to 8.5 GB DL or 4.7 GB standard

Dimensions (W x H x D) 5.04 x 0.37 x 5.0 in (128 x 9.5 x 127 mm) without bezel

Weight (max) 0.31 lb (140 q)

**Read Speeds** DVD-R DL - Up to 6X

> DVD+R - Up to 8X DVD+RW - Up to 8X DVD+R DL - Up to 6X DVD-R - Up to 8X DVD-RW - Up to 6X CD-R - Up to 24X CD-RW - Up to 10X



Technical Specifications — Optical Disc Drives

DVD-RW, DVD+RW - Up to 8X DVD-R DL, DVD+R DL - Up to 8X DVD+R, DVD-R - Up to 8X

DVD-ROM DL, DVD-ROM - Up to 8X

CD-ROM, CD-R - Up to 24X

CD-RW - Up to 24X

Access time (typical reads, including

Full Stroke DVD-ROM: 320 ms (typical), CD-ROM: 320 ms (typical)

settling)

Stop Time 6 seconds (typical)

Power

Source Slimline SATA DC power receptacle

DC Power Requirement 5 VDC ± 5%-100 mV ripple p-p DC Current 5 VDC (< 1000 mA typical, 1600 mA maximum)

Random DVD-ROM: 170 ms (typical), CD-ROM: 170 ms (typical)

Environmental conditions (operating - non-condensing)

Temperature 41° to 122° F (5° to 50° C)

Relative Humidity 10% to 80%

Maximum Wet Bulb Temperature 84° F (29° C)



Technical Specifications - Audio

## **HIGH DEFINITION AUDIO**

**Type** Integrated

HD Audio Codec Realtek ALC3867-CG

Audio I/O Ports Front side Combo jack for supporting CTIA, Rear side Line-in/Line-out/Mic-in jacks

Wavetable Syntheses Yes
Analog Audio Yes
Internal Speaker NA

**DAC Sampling Rates** 16 to 24-bit; 44.1K/ 48 K/96K / 192K Hz

**ADC Sampling Rates** 16 bit, 44.1K/ 48K/ 96K/ 192K Hz



Technical Specifications - Power

#### **POWER SUPPLY**

#### P/S 180W SFF ENTS20L EAP85

Operating Voltage Range 180 – 264 VAC
Rated Voltage Range 200-240V AC
Rated Line Frequency 50/60 HZ
Operating Line Frequency 47 – 63 Hz
Rated Input Current 180W: <1.3A

Rated Input Current with Energy Efficient\* Power

**Supply** 82/85/82% efficient at 20/50/100% load (230V)

DC Output +12.1V

**Current Leakage (NFPA 99:** 

2102)

Less than 500 microamps of leakage current at 120 Vac with the ground wire disconnected, as required for Non-patient Electrical Appliances and Equipment used in a patient care facility or

that contact patients in normal use. Per section 10.3.5.1.

Less than 100 microamps of leakage current at 120 Vac with the ground wire intact with normal polarity, as required for Non-patient Electrical Appliances and Equipment used in a patient care

facility or that contact patients in normal use. Per section 10.3.5.1.

**Power Supply Fan** 50 x 20 mm (linear type)

#### P/S 180W SFF ENTS20L EAP90

Operating Voltage Range90 – 264 VACRated Voltage Range100-240V ACRated Line Frequency50/60 HZOperating Line Frequency47 – 63 HzRated Input Current180W: <2.3A</th>

Rated Input Current with Energy Efficient\* Power

Supply

87/90/87% efficient at 20/50/100% load (115Vac) 88/92/88% efficient at 20/50/100% load (230V)

DC Output +12.1V

Current Leakage (NFPA 99:

2102)

Less than 500 microamps of leakage current at 120 Vac with the ground wire disconnected, as required for Non-patient Electrical Appliances and Equipment used in a patient care facility or

that contact patients in normal use. Per section 10.3.5.1.

Less than 100 microamps of leakage current at 120 Vac with the ground wire intact with normal polarity, as required for Non-patient Electrical Appliances and Equipment used in a patient care

facility or that contact patients in normal use. Per section 10.3.5.1.

**Power Supply Fan** 50 x 20 mm (linear type)

## P/S 240W SFF ENTS20L EAP92

Operating Voltage Range90 – 264 VACRated Voltage Range100-240V ACRated Line Frequency50/60 HZOperating Line Frequency47 – 63 Hz

**Rated Input Current** 240W Platinum ≤ 2.9A



Technical Specifications - Power

**Rated Input Current with Energy Efficient\* Power** 

Supply

90/92/89% efficient at 20/50/100% load (115V) 91/93/90% efficient at 20/50/100% load (230V)

**DC Output** +12V

**Current Leakage (NFPA 99:** 2102)

Less than 500 microamps of leakage current at 264 Vac with the ground wire disconnected, as required for Non-patient Electrical Appliances and Equipment used in a patient care facility or

that contact patients in normal use. Per section 10.3.5.1.

Less than 100 microamps of leakage current at 264 Vac with the ground wire intact with normal polarity, as required for Non-patient Electrical Appliances and Equipment used in a patient care

facility or that contact patients in normal use. Per section 10.3.5.1.

**Power Supply Fan** 50mm variable speed



Technical Specifications – Weights and Dimensions

## **WEIGHTS AND DIMENSIONS**

**Chassis** (W x D x H) 3.74 x 11.93 x 10.63 in (95 x 303 x 270 mm) (w/ bezel)

**System Volume** 463.16cu in

7.6L

System Weight\* 8.82 lbs / 4 kg

**Packaged** 13.46 x 7.72 x 19.65 in (H x W x D) 342 x 196 x 499 mm

**Shipping Weight\*** 13.2 lb / 6 kg **Shipping Weight** 13.86 lb / 6.3 kg

(Molded Pulp)\*

Palletization12-units per layerProfile6 layer max

72 per pallet Footprint (HxWxD) 85.91 x 39.37 x 47.24 in (2182 x 1000 x 1200 mm)

\*NOTE: Weight varies by configuration and component



Technical Specifications – Networking

### **NETWORKING**

## 10/100/1000 Integrated NIC

Ethernet Features 10 Mbit/s operation (10BASE-T; IEEE 802.3i; IEEE 802.3 clauses 13-14)

100 Mbit/s operation (100BASE-TX; IEEE 802.3u; IEEE 802.3 clauses 21-30) 1000 Mbit/s operation (1000BASE-T; IEEE 802.3ab; IEEE 8023 clauses 40)

Auto-Negotiation (Automatic Speed Selection)

Full Duplex Operation at all Speeds, Half Duplex operation at 10 and 100 Mbit/s

**Power Management** ACPI compliant – multiple power modes

Situation-sensitive features reduce power consumption

Advanced link down power saving for reducing link down power consumption

**Performance Features** TCP/IP/UDP Checksum Offload (configurable)

Protocol Offload (ARP & NS)

Large send offload and Giant send offload

Receiving Side Scaling Jumbo Frame 9K

Manageability Wake-on-LAN from standby and hibernation (Magic Packet and Microsoft Wake-Up

Frame); Wake-on-LAN from off (Magic Packet only)

PXE 2.1 Remote Boot

Statistics Gathering (SNMP MIB II, Ethernet-like MIB, Ethernet MIB (802.3x, clause 30))

Comprehensive diagnostic and configuration software suite

Virtual Cable Doctor for Ethernet cable status

### Realtek RTL8821CE-CG 802.11a/b/g/n/ac (1x1) with Bluetooth® wireless card M.2 PCIe®

her decidence to the	IEEE 002 44	UPPER DOD 44	
Wireless LAN Standards1	IEEE 802.11a IEEE 802.11b		
	IEEE 802.11g IEEE 802.11n		
	IEEE 802.1111		
		int and internet service required and sold separately. Availability of public wireless . Wi-Fi 5 (802.11 ac) is backwards compatible with prior 802.11 specs.	
Interoperability	Wi-Fi® certified mo	dules	
Frequency Bands	802.11b/g/n	•2.402 – 2.482 GHz	
		Note: The FCC has declared as of January 1, 2015 products that utilize passive scanning on channel 12/13 and are capable of transmitting must fully comply with requirements of 15.247 or otherwise disable those channels.	
	802.11a/n	•4.9 – 4.95 GHz (Japan)	
		•5.15 – 5.25 GHz	
		•5.25 – 5.35 GHz •5.47 – 5.725 GHz	
		•5.825 – 5.850	
Data Rates • •802.11b: 1, 2, 5.5, 11 Mbps		1, 2, 5.5, 11 Mbps	
	• •802.11g:	• •802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps	
	• •802.11a:	• •802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps	
	• •802.11n:	MCS 0 ~ MCS 15, (20MHz, and 40MHz)	



	• •802.11ac: MCS0 ~ MCS9, (1SS, and 2SS) (20MHz, 40MHz, and 80MHz)	
Modulation	Direct Sequence Spread Spectrum	
	BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM	
Security <sup>2</sup>	• IEEE and 64 / 128 bit WEP encryption for a/b/g mode only	
	• AES-CCMP: 128 bit in hardware	
	*802.1x authentication     *********************************	
	WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.  WPA2 contification.	
	• WPA2 certification     • IEEE 802.11i	
	<ul> <li>• Cisco Certified Extensions, all versions through CCX4 and CCX Lite</li> <li>• WAPI</li> </ul>	
	2 Check latest software/driver release for updates on supported security features.	
Network Architecture	Ad-hoc (Peer to Peer)	
Models	Infrastructure (Access Point Required)	
Roaming	IEEE 802.11 compliant roaming between access points	
Output Power <sup>3</sup>	• • 802.11b: +14dBm minimum	
	• 802.11g: +12dBm minimum	
	• • 802.11a: +12dBm minimum	
	802.11n HT20(2.4GHz): +12dBm minimum	
	• 802.11n HT40(2.4GHz): +12dBm minimum	
	• 802.11n HT20(5GHz): +10dBm minimum	
	• 802.11n HT40(5GHz): +10dBm minimum	
	• 802.11ac VHT80(5GHz): +10dBm minimum	
	3. Maximum output power may vary by country according to local regulations.	
Power Consumption	•Transmit mode2.0 W	
	•Receive mode1.6 W •Idle mode (PSP)180 mW(WLAN Associated)	
	•Idle mode50 mW(WLAN unassociated)	
	•Connected Standby 10mW	
	•Radio disabled8 mW	
Power Management	ACPI and PCI Express compliant power management	
	802.11 compliant power saving mode	
Receiver Sensitivity <sup>4</sup>	802.11b, 1Mbps: -93.5dBm maximum	
	802.11b, 11Mbps: -84dBm maximum 802.11a/g, 6Mbps: -86dBm maximum	
	802.11a/g, 54Mbps: -72dBm maximum	
	802.11n, MCS07: -67dBm maximum	
	802.11n, MCS15: -64dBm maximum	
	802.11ac, MCS0: -84dBm maximum	



Technical Specifications – Networking

	802.11ac, MCS9: -59dBm maxi	mum
	4 Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).	
Antenna type	High efficiency antenna. One embedded dual band 2.4/s communications and Bluetootl	5 GHz antenna is provided to the card to support WLAN n communications
Form Factor	PCI-Express M.2 MiniCard	
Dimensions	Type 2230: 2.3 x 22.0 x 30.0 mm	
Weight	Type 2230: 2.8g	
Operating Voltage	3.3v +/- 9%	
Temperature	Operating: Non-operating:	14° to 158° F (-10° to 70° C) -40° to 176° F (-40° to 80° C)
Humidity	Operating: Non-operating:	10% to 90% (non-condensing) 5% to 95% (non-condensing)
Altitude	Operating: Non-operating:	0 to 10,000 ft (3,048 m) 0 to 50,000 ft (15,240 m)
LED Activity	LED Amber – Radio OFF; LED White – Radio ON	

## HP Integrated Module with Bluetooth 4.0/4.1/4.2 Wireless Technology

Bluetooth Specification	4.0/4.1/4.2 Compliant
Frequency Band 2402 to 2480 MHz	
Number of Available Channels	Legacy: 0~79 (1 MHz/CH) BLE: 0~39 (2 MHz/CH)
Data Rates and Throughput  Legacy: 3 Mbps data rate; throughput up to 2.17 Mbps  BLE: 1 Mbps data rate; throughput up to 0.2 Mbps  Legacy: Synchronous Connection Oriented links up to 3, 64 kbps, voice chan  Legacy: Asynchronous Connection Less links 2178.1 kbps/177.1 kbps asymmetric (3-EV5)	
<b>Transmit Power</b> The Bluetooth component shall operate as a Class II Bluetooth device with a maxim transmit power of + 4 dBm for BR and EDR.	
Receiver Sensitivity Legacy	
Power Consumption  Peak (Tx) 330 mW  Peak (Rx) 230 mW  Selective Suspend 17 mW	
Range	Legacy: 0~79 (1 MHz/CH) BLE: 0~39 (2 MHz/CH)
Electrical Interface USB 2.0 compliant	



Technical Specifications – Networking

Bluetooth Software Supported Link Topology	Microsoft Windows Bluetooth Software	
Power Management Certifications	Microsoft Windows ACPI, and USB Bus Support	
Certifications Bluetooth Profiles Supported	BT4.1-ESR 5/6/7 Compliance LE Link Layer Ping LE Dual Mode LE Link Layer LE Low Duty Cycle Directed Advertising LE L2CAP Connection Oriented Channels Train Nudging & Interlaced Scan BT4.2 ESR08 Compliance LE Secure Connection- Basic/Full LE Privacy 1.2 –Link Layer Privacy LE Privacy 1.2 –Extended Scanner Filter Policies LE Data Packet Length Extension FAX Profile (FAX) Basic Imaging Profile (BIP)2 Headset Profile (HSP) Hands Free Profile (HFP) Advanced Audio Distribution Profile (A2DP)	

### Realtek RTL8822CE 802.11ac 2x2 Wi-Fi + BT5.1 wireless card

Wireless LAN Standards	IEEE 802.11a
	IEEE 802.11b
	IEEE 802.11g
	IEEE 802.11n
	IEEE 802.11ac
	IEEE 802.11d
	IEEE 802.11e
	IEEE 802.11h
	IEEE 802.11i
	IEEE 802.11k
	IEEE 802.11r
	IEEE 802.11v
	1. Wireless access point and internet service required and sold separately. Availability of public
	wireless access points limited. Wi-Fi 5 (802.11 ac) is backwards compatible with prior 802.11 specs.
Interoperability	Wi-Fi® certified
Frequency Band	802.11b/g/n
	• 2.402 – 2.482 GHz
	802.11a/n/ac
	• 4.9 – 4.95 GHz (Japan)
	• 5.15 – 5.25 GHz
	• 5.25 – 5.35 GHz
	• 5.47 – 5.725 GHz
	• 5.825 – 5.850 GHz
	1



Data Rates	• 802.11b: 1, 2, 5.5, 11 Mbps		
	• 802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps		
	• 802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps		
	• 802.11n: MCS 0 ~ MCS 15, (20MHz, and 40MHz)		
	• 802.11ac: MCS0 ~ MCS9, (1SS, and 2SS) (20MHz, 40MHz & 80MHz)		
Modulation	Direct Sequence Spread Spectrum		
	BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM		
Security <sup>2</sup>	• IEEE and Wi-Fi compliant 64 / 128 bit WEP encryption for a/b/g mode only • AES-CCMP: 128 bit in hardware		
	• 802.1x authentication		
	WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.		
	WPA, WPAZ. 802.1X. WPA-PSK, WPAZ-PSK, TKIP, dilu AES.  WPAZ certification		
	• IEEE 802.11i		
	• WAPI		
	2 Check latest software/driver release for updates on supported security features.		
Network Architecture Models	Ad-hoc (Peer to Peer)		
	Infrastructure (Access Point Required)		
Roaming	IEEE 802.11 compliant roaming between access points		
Output Power³	• 802.11b: +18.5dBm minimum		
	• 802.11g: +17.5dBm minimum		
	• 802.11a: +18.5dBm minimum		
	• 802.11n HT20(2.4GHz): +15.5dBm minimum		
	• 802.11n HT40(2.4GHz): +14.5dBm minimum		
	• 802.11n HT20(5GHz): +15.5dBm minimum • 802.11n HT40(5GHz): +14.5dBm minimum		
	• 802.11ac VHT80(5GHz): +11.5dBm minimum		
	• 802.11ac VHT160(5GHz): +11.5dBm minimum		
	3. Maximum output power may vary by country according to local regulations.		
Power Consumption	• Transmit mode:2.0 W • Receive mode:1.6 W		
	• Idle mode (PSP) 180 mW (WLAN Associated)		
	• Idle mode:50 mW (WLAN unassociated)		
	Connected Standby/Modern Standby: 10mW		
	• Radio disabled: 8 mW		
Daway Managamant	ACDI and DCI Everyors compliant power management		
Power Management	ACPI and PCI Express compliant power management 802.11 compliant power saving mode		
Receiver Sensitivity <sup>4</sup>	802.11b, 1Mbps: -93.5dBm maximum		
-	802.11b, 11Mbps: -84dBm maximum		
	802.11a/g, 6Mbps: -86dBm maximum		
	802.11a/g, 54Mbps: -72dBm maximum		
	802.11n, MCS07: -67dBm maximum		
	802.11n, MCS15: -64dBm maximum		
	802.11ac, MCSO: -84dBm maximum		
	802.11ac, MCS9: -59dBm maximum		
	4 Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a		
	packet error rate of 10% for 802.11a/g (OFDM modulation).		



Automorphic -	High officions and are a cital and all discourses and in the discourse and are	
Antenna type	High efficiency antenna with spatial diversity, mounted in the display enclosure	
	Two embedded dual band 2.4/5 GHz antennas are provided to the card to support WLAN	
	MIMO communications and Bluetooth communications	
Form Factor	PCI-Express M.2 MiniCard with CNVi Interface	
Dimensions	1. Type 2230: 2.3 x 22.0 x 30.0 mm	
	2. Type 1216: 1.67 x 12.0 x 16.0 mm	
Weight	1. Type 2230: 2.8g 2. Type 126: 1.3g	
Operating Voltage	3.3v +/- 9%	
Temperature	<b>Operating:</b> 14° to 158° F (–10° to 70° C) <b>Non-operating:</b> –40° to 176° F (–40° to 80° C)	
Uidit	Operating: 10% to 90% (non-condensing)	
Humidity	Non-operating: 5% to 95% (non-condensing)	
Altitude	<b>Operating:</b> 0 to 10,000 ft (3,048 m)	
	<b>Non-operating:</b> 0 to 50,000 ft (15,240 m)	
LED Activity	LED Amber – Radio OFF;	
	LED OFF – Radio ON	
HP Integrated Module with Bl	uetooth 4.0/4.1/4.2/5.0 Wireless Technology	
Bluetooth Specification	4.0/4.1/4.2/5.0 Compliant	
Frequency Band	2402 to 2480 MHz	
Number of Available Channels	Legacy: 0~79 (1 MHz/CH) BLE: 0~39 (2 MHz/CH)	
Data Rates and Throughput	Legacy: 3 Mbps data rate; throughput up to 2.17 Mbps	
	BLE: 1 Mbps data rate; throughput up to 0.2 Mbps	
	Legacy: Synchronous Connection Oriented links up to 3, 64 kbps, voice channels Legacy: Asynchronous Connection Less links 2178.1 kbps/177.1 kbps asymmetric (3-DH5) or	
	864 kbps symmetric (3-EV5)	
Transmit Power  The Bluetooth component shall operate as a Class II Bluetooth device with transmit power of + 4 dBm for BR and EDR.		
Power Consumption	Peak (Tx): 330 mW	
	Peak (Rx): 230 mW	
	Selective Suspend: 17 mW	
Bluetooth Software Supported	Microsoft Windows Bluetooth Software	
Link Topology		
Power Management	Microsoft Windows ACPI, and USB Bus Support	
Certifications	FCC (47 CFR) Part 15C, Section 15.247 & 15.249	
Power Management	ETS 300 328, ETS 300 826	
	Low Voltage Directive IEC60950-1/IEC62368-1	
Certifications	UL, CSA, and CE Mark	
Bluetooth Profiles Supported	BT4.1-ESR 5/6/7 Compliance	
	LE Link Layer Ping	
	LE Dual Mode LE Link Layer	
	LE Low Duty Cycle Directed Advertising	



# Technical Specifications – Networking

LE L2CAP Connection Oriented Channels Train Nudging & Interlaced Scan BT4.2 ESR08 Compliance LE Secure Connection- Basic/Full LE Privacy 1.2 –Link Layer Privacy LE Privacy 1.2 –Extended Scanner Filter Policies LE Data Packet Length Extension FAX Profile (FAX) Basic Imaging Profile (BIP)2 Headset Profile (HSP) Hands Free Profile (HFP) Advanced Audio Distribution Profile (A2DP)

## Realtek 8852BE Wi-Fi6 +BT5.2 wireless card WLAN<sup>1</sup>

Wireless LAN Standards	IEEE 802.11a IEEE 802.11g IEEE 802.11n IEEE 802.11ac IEEE 802.11d IEEE 802.11e IEEE 802.11e IEEE 802.11h IEEE 802.11h IEEE 802.11r IEEE 802.11r IEEE 802.11r		
Interesperability	Wireless access point and Internet service required and sold separately. Availability of public wireless access points limited. Wi-Fi 6 (802.11ax) is backwards compatible with prior 802.11 specs.  Wi Fi® contified.		
Interoperability	Wi-Fi® certified		
Frequency Band	802.11b/g/n • 2.402 – 2.482 GHz 802.11a/n/ac • 4.9 – 4.95 GHz (Japan) • 5.15 – 5.25 GHz • 5.25 – 5.35 GHz • 5.47 – 5.725 GHz • 5.825 – 5.850 GHz		
Data Rates	<ul> <li>802.11b: 1, 2, 5.5, 11 Mbps</li> <li>802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps</li> <li>802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps</li> <li>802.11n: MCS 0 ~ MCS 15, (20MHz, and 40MHz)</li> <li>802.11ac: MCS0 ~ MCS9, (1SS, and 2SS) (20MHz, 40MHz &amp; 80MHz)</li> </ul>		
Modulation	Direct Sequence Spread Spectrum BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM		



Security <sup>2</sup>	• IEEE and Wi-Fi compliant 64 / 128 bit WEP encryption for a/b/g mode only
	AES-CCMP: 128 bit in hardware
	• 802.1x authentication
	• WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.
	WPA2 certification
	• IEEE 802.11i
	• WAPI
	2 Check latest software/driver release for updates on supported security features.
Network Architecture Models	Ad-hoc (Peer to Peer)
	Infrastructure (Access Point Required)
Roaming	IEEE 802.11 compliant roaming between access points
Output Power³	• 802.11b: +18.5dBm minimum
	• 802.11g: +17.5dBm minimum
	• 802.11a: +18.5dBm minimum
	• 802.11n HT20(2.4GHz): +15.5dBm minimum
	• 802.11n HT40(2.4GHz): +14.5dBm minimum
	• 802.11n HT20(5GHz): +15.5dBm minimum
	• 802.11n HT40(5GHz): +14.5dBm minimum
	• 802.11ac VHT80(5GHz): +11.5dBm minimum
	• 802.11ac VHT160(5GHz): +11.5dBm minimum
	3. Maximum output power may vary by country according to local regulations.
Power Consumption	• Transmit mode:2.0 W
	• Receive mode:1.6 W
	• Idle mode (PSP) 180 mW (WLAN Associated)
	• Idle mode:50 mW (WLAN unassociated)
	Connected Standby/Modern Standby: 10mW
	• Radio disabled: 8 mW
Power Management	ACPI and PCI Express compliant power management
	802.11 compliant power saving mode
Receiver Sensitivity <sup>4</sup>	802.11b, 1Mbps: -93.5dBm maximum
	802.11b, 11Mbps: -84dBm maximum
	802.11a/g, 6Mbps: -86dBm maximum
	802.11a/g, 54Mbps: -72dBm maximum
	802.11n, MCS07: -67dBm maximum
	802.11n, MCS15: -64dBm maximum
	802.11ac, MCS0: -84dBm maximum
	802.11ac, MCS9: -59dBm maximum
	4 Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).
Antenna type	High efficiency antenna with spatial diversity, mounted in the display enclosure
	Two embedded dual band 2.4/5 GHz antennas are provided to the card to support WLAN
	MIMO communications and Bluetooth communications
Form Factor	PCI-Express M.2 MiniCard with CNVi Interface
Form Factor Dimensions	PCI-Express M.2 MiniCard with CNVi Interface  1. Type 2230: 2.3 x 22.0 x 30.0 mm



Weight	1. Type 2230: 2.8g 2. Type 126: 1.3g		
Operating Voltage	3.3v +/- 9%		
Temperature	<b>Operating:</b> 14° to 158° F (–10° to 70° C) <b>Non-operating:</b> –40° to 176° F (–40° to 80° C)		
Humidity	Operating: 10% to 90% (non-condensing) Non-operating: 5% to 95% (non-condensing)		
Altitude	<b>Operating:</b> 0 to 10,000 ft (3,048 m) <b>Non-operating:</b> 0 to 50,000 ft (15,240 m)		
LED Activity	LED Amber – Radio OFF; LED OFF – Radio ON		
HP Integrated Module with Bl	uetooth® 4.0/4.1/4.2/5.0 Wireless Technology		
Bluetooth Specification	4.0/4.1/4.2/5.0 Compliant		
Frequency Band	2402 to 2480 MHz		
Number of Available Channels	Legacy: 0~79 (1 MHz/CH) BLE: 0~39 (2 MHz/CH)		
Data Rates and Throughput	Legacy: 3 Mbps data rate; throughput up to 2.17 Mbps BLE: 1 Mbps data rate; throughput up to 0.2 Mbps Legacy: Synchronous Connection Oriented links up to 3, 64 kbps, voice channels Legacy: Asynchronous Connection Less links 2178.1 kbps/177.1 kbps asymmetric (3-DH5) or 864 kbps symmetric (3-EV5)		
Transmit Power	The Bluetooth component shall operate as a Class II Bluetooth device with a maximum transmit power of + 4 dBm for BR and EDR.		
Power Consumption	Peak (Tx): 330 mW Peak (Rx): 230 mW Selective Suspend: 17 mW		
Bluetooth Software Supported	Microsoft Windows Bluetooth Software		
Link Topology			
Power Management	Microsoft Windows ACPI, and USB Bus Support		
Certifications	FCC (47 CFR) Part 15C, Section 15.247 & 15.249		
Power Management	ETS 300 328, ETS 300 826 Low Voltage Directive IEC60950-1/IEC62368-1		
Certifications	UL, CSA, and CE Mark		
Bluetooth Profiles Supported	BT4.1-ESR 5/6/7 Compliance LE Link Layer Ping LE Dual Mode LE Link Layer LE Low Duty Cycle Directed Advertising LE L2CAP Connection Oriented Channels Train Nudging & Interlaced Scan BT4.2 ESR08 Compliance LE Secure Connection- Basic/Full LE Privacy 1.2 -Link Layer Privacy LE Privacy 1.2 -Extended Scanner Filter Policies LE Data Packet Length Extension FAX Profile (FAX) Basic Imaging Profile (BIP)2		



Headset Profile (HSP) Hands Free Profile (HFP) Advanced Audio Distribution Profile (A2DP)	
---	--



After-Market Options (availability may vary by region)

## **AFTER MARKET OPTIONS**

Туре	Description	<u> Part #</u>	
Memory	HP 4GB DDR4-3200 DIMM	13L78AA	
	HP 8GB DDR4-3200 DIMM	13L76AA	
	HP 16GB DDR4-3200 DIMM	13L74AA	
	HP 32GB DDR4-3200 DIMM	13L72AA	
Storage	HP PCIe Gen 4 NVME TLC M.2 512GB SSD	406L8AA	
	HP PCIe Gen 4 NVME TLC M.2 1TB SSD	406L7AA	
	HP 500GB 7200PRM SATA 6.0Gb/s 3.5" Hard Drive	QK554AA	
	HP 1TB 7200rpm SATA 6Gb/s 3.5" Hard Drive	QK555AA	
	HP PCIe Gen 4 NVME TLC M.2 1TB SSD	406L7AA	
Graphics	NVIDIA T400 4GB GDDR6 3mDP	5Z7E0AA	
	AMD Radeon RX 6300 2GB GDDR6 DP + HDMI	7Y6P7AA	
Security	HP Business PC Security Lock V3 Kit	3XJ17AA	
Jecurity	HP Keyed Cable Lock 10mm kit	T1A62AA	
Adapters	HP PCIe x1 Parallel Port Card	N1M40AA	
nuupteis	HP HDMI Standard Cable Kit	T6F94AA	
	HP USB to Serial Port Adapter	J7B60AA	
	DisplayPort Cable Kit	VN567AA	
Networking	Intel Ethernet I225-T1 GbE NIC Card	406L9AA	
Input	HP Wired Desktop 320K Keyboard	9SR37AA	
	HP 125 Wired Mouse	265A9AA	
	HP 225 Wired Mouse and Keyboard Combo	286J4AA	
	HP 225 Antimicrobial Wired Mouse and Keyboard Combo	286K3AA	
	HP Wired Desktop 320K Keyboard	9SR37AA	
_	HP Wired Desktop 320M Mouse	9VA80AA	
	HP 125 Wired Keyboard	266C9AA	
	HP 125 Wired Mouse	265A9AA	



## Change Log

© Copyright 2025 HP Development Company, L.P.

The information contained herein is subject to change without notice. The only warranties for HP products are set forth in the express limited warranty statements accompanying such products. Nothing herein should be construed as constituting an additional warranty. HP shall not be liable for technical or editorial errors or omissions contained herein.

Microsoft and Windows are registered trademarks or trademarks of Microsoft Corporation in the U.S. and/or other countries. Intel, Celeron®, Core, Pentium are registered trademarks or trademarks of Intel Corporation in the U.S. and/or other countries. Bluetooth is a trademark of its proprietor, used by HP Inc. under license. NVIDIA, GeForce, Kepler and NVS are trademarks and/or registered trademarks of NVIDIA Corporation in the U.S. and other countries. AMD and Radeon are trademarks of Advanced Micro Devices, Inc. DisplayPort™ and the DisplayPort™ logo are trademarks owned by the Video Electronics Standards Association (VESA®) in the United States and other countries.

Wi-Fi® is a registered trademark of Wi-Fi Alliance®.

Date of change:	Version History:		Description of change:
June 21, 2023	From v1 to v2	Correction	Sku's for adapters in AMO corrected
August 17, 2023	From v2 to v3	Update	Back call outs image updated
August 21, 2023	From v3 to v4	Addition	Serial port (optional) added to Rear ports section
November 25, 2024	From v4 to v5	Update	256GB/512GB/1TB M.2 2280 PCIe NVMe SSD tables updated
March 10, 2025	From v5 to v6	Update	256GB/512GB/1TB PCIE NVME SSD "Value" added on description as long as 4x4 into Interface, the 2nd NOTE: PCIe Gen4 based removed
	From v6 to v7		
	From v7 to v8		
	From v8 to v9		
	From v9 to v10		
	From v10 to v11		
	From v11 to v12		

